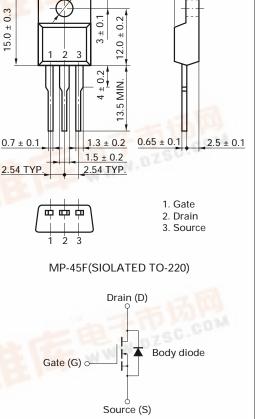


SWITCHING N-CHANNEL POWER MOS FET **INDUSTRIAL USE**

DESCRIPTION PACKAGE DIMENSIONS The 2SK2341 is N-channel Power MOS Field Effect Transis-(in millimeters) tor designed for high voltage switching applications. 10.0 ± 0.3 **FEATURES** $\phi 3.2 \pm 0.2$ Low On-state Resistance $R_{DS(on)} = 0.26 \Omega MAX. (V_{GS} = 10 V, I_{D} = 6.0 A)$ • Low Ciss Ciss = 1090 pF TYP. 5.0 ± 0.3 0.1 ± 0.2 High Avalanche Capability Ratings 0 ABSOLUTE MAXIMUM RATINGS (TA = 25 °C) 0.2 Drain to Source Voltage VDSS 250 V Gate to Source Voltage VGSS +30V Drain Current (DC) D (DC) ±11 А 0.7 ± 0.1 1.3 ± 0.2 Drain Current (pulse) D (pulse)* ± 44 А 1.5 ± 0.2 Total Power Dissipation (Tc = 25 °C) PT1 35 W 2.54 TYP. 2.54 TYP. Total Power Dissipation (Ta = 25 °C) PT2 2.0 W Tstg -55 to +150 °C Storage Temperature фф **Channel Temperature** Tch 150 °C 11 Single Avalanche Current As** А 2 Single Avalanche Energy Eas** 320 m.J *PW \leq 10 μ s, Duty Cycle \leq 1 % **Starting T_{ch} = 25 °C, R_G = 25 Ω , V_{GS} = 20 V \rightarrow 0 Drain (D)

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be WWW.DZSC.COM applied to this device.



 4.5 ± 0.2

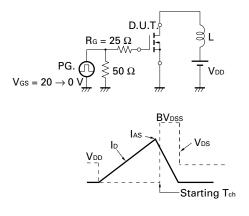
 2.7 ± 0.2



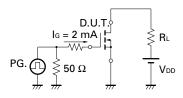
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-state Resistance	RDS(on)		0.21	0.26	Ω	$V_{GS} = 10 V, I_{D} = 6 A$
Gate to Source Cutoff Voltage	VGS(off)	2.0		4.0	V	$V_{DS} = 10 V, I_{D} = 1 mA$
Forward Transfer Admittance	y _{fs}	3.0			S	$V_{DS} = 10 V, I_{D} = 6 A$
Drain Leakage Current	IDSS			100	μA	$V_{DS} = 250V, V_{GS} = 0$
Gate to Source Leakage Current	lgss			±100	nA	$V_{GS} = \pm 30 \text{ V}, \text{ V}_{DS} = 0$
Input Capacitance	Ciss		1090		pF	V _{DS} = 10 V
Output Capacitance	Coss		420		pF	Vgs = 0
Reverse Transfer Capacitance	Crss		80		pF	f = 1 MHz
Turn-On Delay Time	td(on)		20		ns	Vgs = 10 V
Rise Time	tr		20		ns	Vdd = 150 V
Turn-Off Delay Time	td(off)		50		ns	$I_D = 6 A, R_G = 10 \Omega$
Fall Time	tr		15		ns	RL = 25 Ω
Total Gate Charge	Q _G		33		nC	Vgs = 10 V
Gate to Source Charge	Qgs		6.0		nC	ID = 11 A
Gate to Drain Charge	Qgd		13		nC	VDD = 200 V
Diode Forward Voltage	VF(S-D)		1.0		V	IF = 11 A, VGS = 0
Reverse Recovery Time	trr		220		ns	1f = 11 A
Reverse Recovery Charge	Qrr		1.0		μC	di/dt = 50 A/µs

ELECTRICAL CHARACTERISTICS (T_A = 25 $^{\circ}$ C)

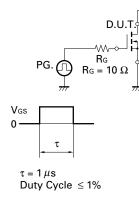
Test Circuit 1 : Avalanche Capability

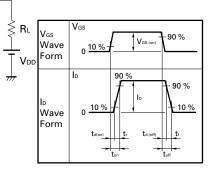


Test Circuit 3 : Gate Charge

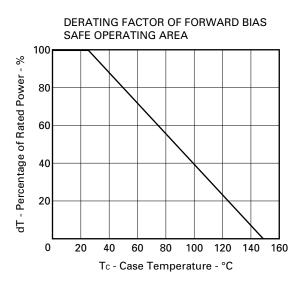


Test Circuit 2 : Switching Time



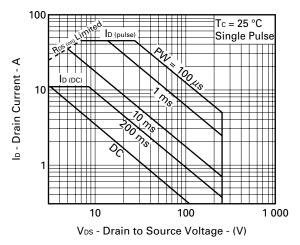


The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

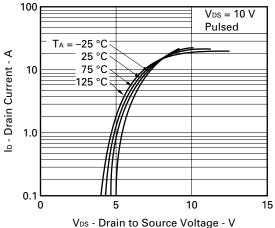


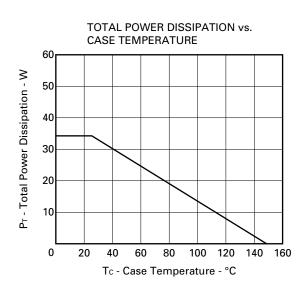
TYPICAL CHARACTERISTICS (TA = 25 °C)

FORWARD BIAS SAFE OPRATING AREA

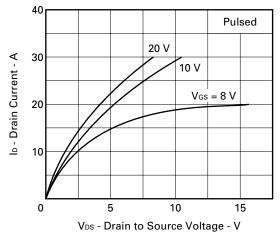


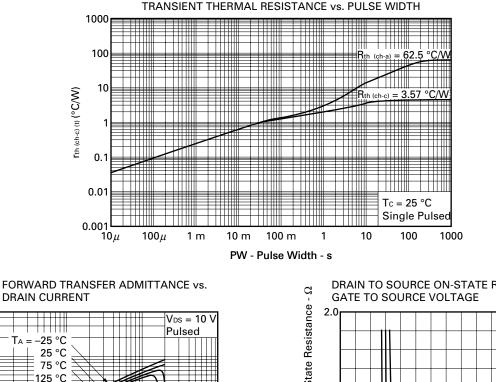
TRANSFER CHARACTERISTICS



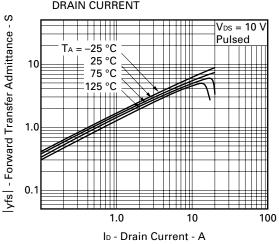


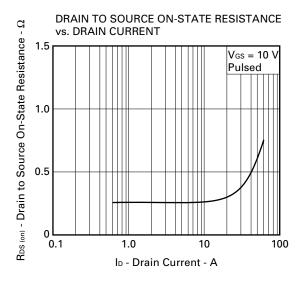
DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE



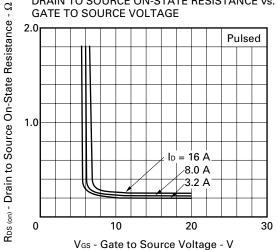


DRAIN CURRENT

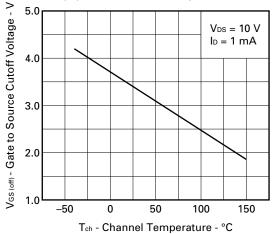


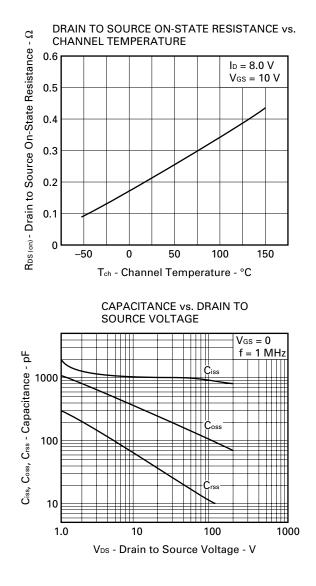


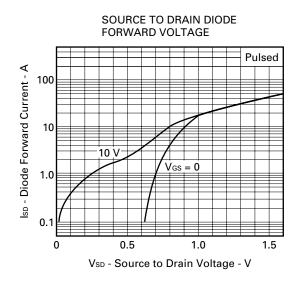
DRAIN TO SOURCE ON-STATE RESISTANCE vs.



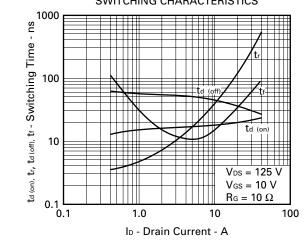
GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE

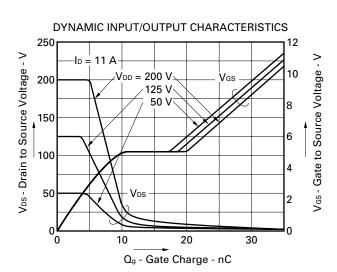




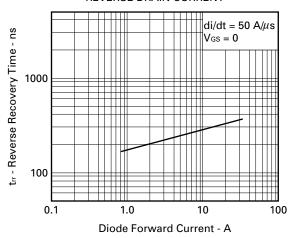


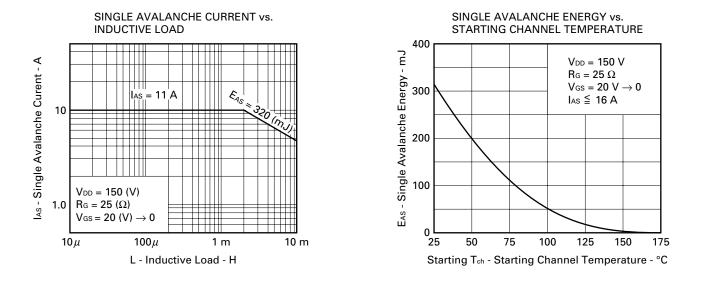
SWITCHING CHARACTERISTICS





REVERSE RECOVERY TIME vs. **REVERSE DRAIN CURRENT**





REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

2SK2341

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